

## EFFECT OF Ga<sub>2</sub>O<sub>3</sub> NANOPARTICLES DISPERSION ON MICROSTRUCTURE AND THERMOELECTRIC PROPERTIES OF p-TYPE BiSbTe BASED ALLOYS

In this study, p-type Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> based nanocomposites with addition of different weight percentages of Ga<sub>2</sub>O<sub>3</sub> nanoparticles are fabricated by mechanical milling and spark plasma sintering. The fracture surfaces of all Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> nanocomposites exhibited similar grain distribution on the entire fracture surface. The Vickers hardness is improved for the Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> nanocomposites with 6 wt% added Ga<sub>2</sub>O<sub>3</sub> due to exhibiting fine microstructure, and dispersion strengthening mechanism. The Seebeck coefficient of Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> nanocomposites are significantly improved owing to the decrease in carrier concentration. The electrical conductivity is decreased rapidly upon the addition of Ga<sub>2</sub>O<sub>3</sub> nanoparticle due to increasing carrier scattering at newly formed interfaces. The peak power factor of 3.24 W/mK<sup>2</sup> is achieved for the base Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> sintered bulk. The Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> nanocomposites show low power factor than base sample due to low electrical conductivity.

*Keywords:* Thermoelectric properties, Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> alloys, Seebeck coefficient, Mechanical alloying, Spark plasma sintering

### 1. Introduction

Thermoelectric (TE) solid state devices have been developed for power generation and refrigeration cooling applications. The performance of thermoelectric devices is determined by a dimensionless figure of merit,  $ZT = \alpha^2 \sigma T / \kappa$ , where  $\alpha$  is the Seebeck coefficient,  $\sigma$  is the electrical conductivity,  $\kappa$  is the thermal conductivity,  $T$  is the absolute temperature respectively. The TE materials with high power factor ( $\alpha^2 \sigma$ ), and low thermal conductivity ( $\kappa$ ) are required to get high figure of merit values [1].

Bismuth-telluride based alloys show exceptional TE properties at ambient temperatures, and employed for commercial TE modules over the past five decades. These alloys have a narrow energy gap, and can vary the electrical properties by doping. In addition, Bi-Sb-Te based compounds have a rhombohedral crystal structure (space group  $R\bar{3}m$ ), with weak force of van der Waals bonding between the successive Te-Te layers, can easily be occupied by foreign atoms (modulations) [2,3]. So far, commercial ingots of p-type and n-type Bi-Te based alloys are fabricated by single crystal (zone melting) techniques. However, these conventional processes include complex processing procedures such as high annealing temperature, and difficult to control the exact composition with stoichiometric ratios. In addition, zone melting (ZM) bulks have cleave along the  $c$ -direction due to weak van der Waals forces between Te<sup>(1)</sup>-Te<sup>(1)</sup> layers [4]. Recently, powder metallurgy come forward to overcome these problem, and achieved high thermoelectric as well as mechanical properties

[5]. Poudel et al. fabricated p-type Bi-Te based alloys with ZT of 1.4 via bulk nanostructuring approach at 400K by ball milling and hot pressing [6]. Xie et al. reported the Bi-Sb-TE ternary alloys with improved thermoelectric performance by reduction in thermal conductivity via scattering mechanism [7].

Later, nanocomposites were come forward to improve the thermoelectric performance as well as mechanical properties, where the numerous interfaces would severely have scattered the charge carriers and phonons. On the other hand, heterojunction potentials were formed by the incorporation of metallic nano-inclusions there by significant increase in Seebeck coefficient, as well as carrier mobility. However, the dispersed nanoparticles would also affect the electrical conductivity via carrier scattering at interfaces [8]. Zhao et al. reported the ZT of 1.04 in SiC dispersed Bi<sub>2</sub>Te<sub>3</sub> poly crystals due to reduction in thermal conductivity via defect scattering mechanism, and improved the mechanical properties such as fracture toughness of 1.34 MPa m<sup>1/2</sup> [9]. However, the dispersion of nanoceramic (insulating) particles in p-type Bi-Te alloys are not studied yet. In addition, it is quite interesting to investigate the transport properties with addition of insulators in p-type Bi-Te based alloys.

In this research, Ga<sub>2</sub>O<sub>3</sub> nanoparticles were selected to be dispersed into the Bi<sub>0.5</sub>Sb<sub>1.5</sub>Te<sub>3</sub> matrix, because it is a wide band gap semiconductor and promotes high inclusion stability with in the host matrix [10]. Besides, the dispersed Ga<sub>2</sub>O<sub>3</sub> nanoparticles can enhance the mechanical properties such as hardness, which can benefit for the prevention of cutting loss during the device

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fabrication. Also, the dispersion effect of  $\text{Ga}_2\text{O}_3$  nanoparticles on the microstructure and thermoelectric properties were systematically investigated.

## 2. Experimental

The elements such as Bismuth (99.999%), Antimony (99.99%), tellurium (99.999%), and  $\text{Ga}_2\text{O}_3$  used in the study were purchased from Alfa-acer. Initially, p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  was prepared by gas atomization like our previous studies [11]. The p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposite powders were fabricated by the incorporation of  $\text{Ga}_2\text{O}_3$  nanoparticles into the gas atomized powders by ball milling (Planetary miller P100), subsequently the nanocomposite powders were consolidated by spark plasma sintering with an axial compressive pressure of 50 MPa at 673 K.

The microstructure and chemical analysis of sintered samples were characterized with field- emission scanning electron microscopy, and energy dispersive spectroscopy (SEM- MIRA LMH II (TESKAN), Czech Republic). The crystal structure was analyzed by X-ray diffraction using monochromatic  $\text{CuK}_\alpha$  by MiniFlux 600 (Rigaku) system. The relative density, and hardness of the nanocomposites were measured by Archimedes principle, and Vickers hardness tester respectively. The temperature dependence of thermoelectric properties such as Seebeck coefficient, electrical conductivity was measured with the temperature range of 300–400K using thermoelectric power (Seepel, TEP-1000) measurement system. The power factor was calculated from the Seebeck coefficient, and electrical conductivity. The carrier concentration and, hall mobility is measured using Hall-coefficient measurement system (ECOPIA, HMS-3000).

## 3. Results and discussion

The XRD pattern of the p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposite bulks are illustrated in the Figure 1. It is evident that the all sintered samples were polycrystalline of  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  phases (JCPDS #49-1713) with rhombohedral crystal structure. The diffraction peaks corresponding to the  $\text{Ga}_2\text{O}_3$  phases are not observed clearly, which might be due to the small weight percentages of  $\text{Ga}_2\text{O}_3$  nanoparticles in the matrix. In addition, the intensity of the basal planes is weak, and almost same for all samples, which reveals that no orientation of grains in any special direction is observed [12].

The SEM fracture surfaces of base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample and nanocomposites are presented in Figure 2. The base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  fracture surface in Figure 2(a) shows clean and fine grains distribution with an average grain size of  $\sim 4$  to  $5 \mu\text{m}$ . Figure 2(b), (c), and (d) shows the fracture surfaces of 2, 4 and 6wt%  $\text{Ga}_2\text{O}_3$  dispersed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites. It is obvious that the grain sizes in nanocomposites are slightly decreases than base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample. This slight refinement of grain size from 5 to  $2 \mu\text{m}$  might have attributed to the dispersion effect in which the  $\text{Ga}_2\text{O}_3$  nanoparticles would restrict the grain growth

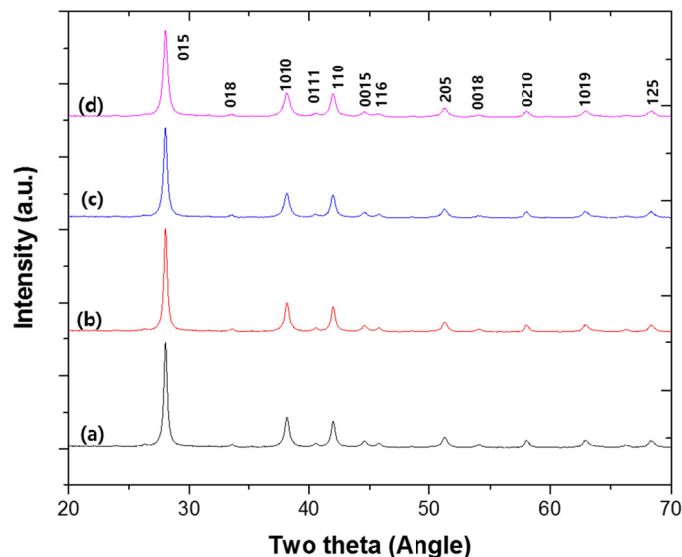


Fig. 1. XRD analysis p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  with (a) 0 wt%  $\text{Ga}_2\text{O}_3$ , (b) 2 wt%  $\text{Ga}_2\text{O}_3$  (c) 4 wt%  $\text{Ga}_2\text{O}_3$ , and (d) 6 wt%  $\text{Ga}_2\text{O}_3$  bulks

during the sintering [13]. The reduction in grain size could be favor for increase in mechanical properties such as hardness, which helps for the preventing the cutting loss during TE device fabrication. In addition, the insets shown in Figure 2(b), (c) and (d) are represent the EDS mapping analysis of nanocomposites and identifies the Ga element distribution in matrix. This results confirm that the  $\text{Ga}_2\text{O}_3$  nanoparticles existence in the base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  matrix. Moreover, Figure 3(a) and 3(b) represents the back-scattered micrographs of 2, and 6 wt%  $\text{Ga}_2\text{O}_3$  added  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites. It is evident that the clear visible (black color contrast)  $\text{Ga}_2\text{O}_3$  nanoparticles are distributed uniformly throughout the surface, and identified with EDS-chemical analysis in Figures 3(c), and (d) respectively. The elemental composition details in spectrum reveals the existence of  $\text{Ga}_2\text{O}_3$  nanoparticles in the  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites.

The relative density and Vickers hardness of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites are listed in Table 1. The relative density is almost 100 % for the base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  materials, and its value is decreased upon the dispersion of  $\text{Ga}_2\text{O}_3$  content in matrix from 2 to 6wt%. The dispersed  $\text{Ga}_2\text{O}_3$  nanoparticles would give the back force during the sintering which might cause for lower densities in nanocomposites [14]. The Vickers hardness values of  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites are shown in Table 1. The Vickers hardness value of base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample is measured of 0.86 GPa, and increased 0.1336 GPa with increasing in  $\text{Ga}_2\text{O}_3$  content. The improved hardness values are attributed to the slight refinement of the grain size (from  $\sim 5$  to  $\sim 2 \mu\text{m}$ ) in nanocomposites, where fine grains could prevent the cracks propagation upon the indentation load. Also, the distributed  $\text{Ga}_2\text{O}_3$  nanoparticles could increase the hardness due to dispersion strengthening mechanism. The present work shows improved hardness than other Bi-Te based nanocomposites reported elsewhere [15,16].

The temperature dependence of the Seebeck coefficient of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites is presented in Figure 4.

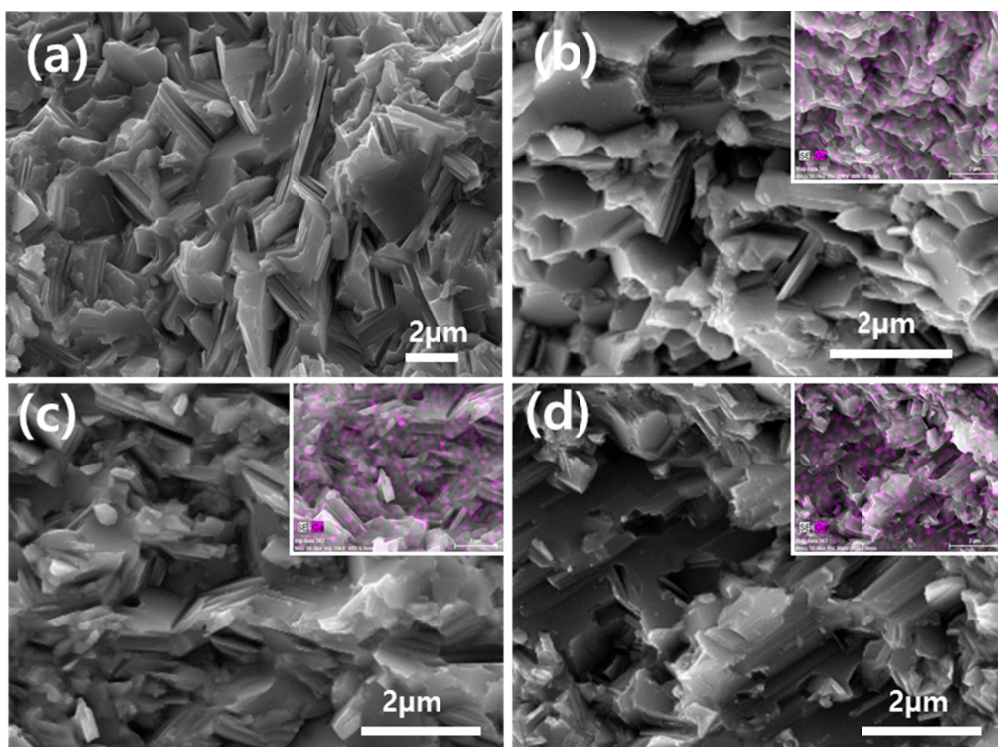


Fig. 2. Fracture surfaces of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  with (a) 0 wt%  $\text{Ga}_2\text{O}_3$ , (b) 2 wt%  $\text{Ga}_2\text{O}_3$  (c) 4 wt%  $\text{Ga}_2\text{O}_3$  ,and (d) 6 wt%  $\text{Ga}_2\text{O}_3$  bulks. The inset in (b), (c) and (d) shows the corresponding EDS mapping images

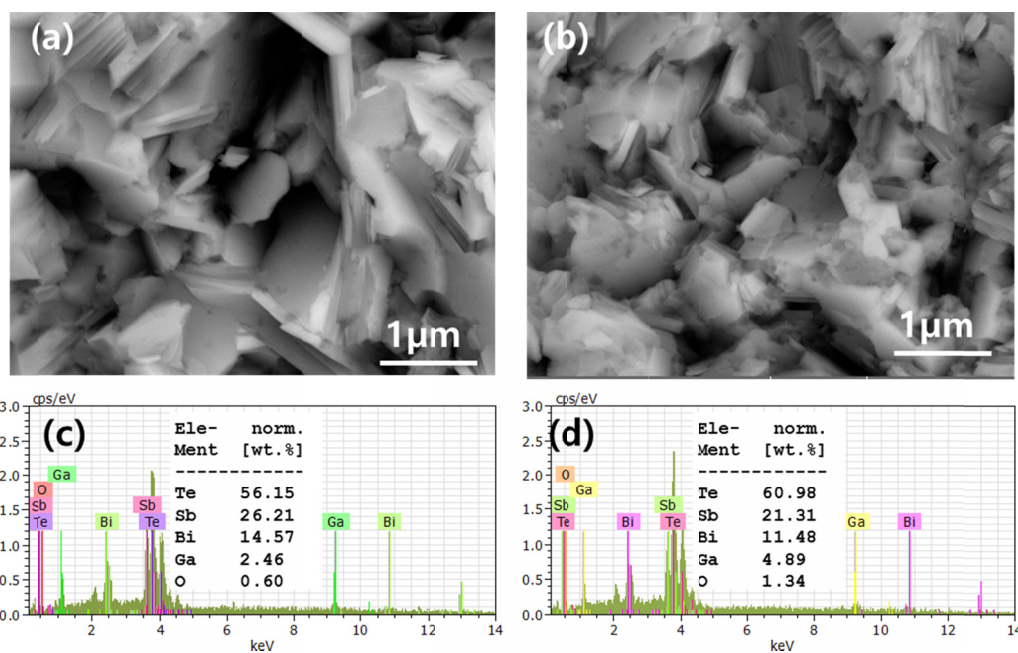


Fig. 3. SEM-BSE micrographs of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  with (a) 2 wt%  $\text{Ga}_2\text{O}_3$ , and (d) 6 wt%  $\text{Ga}_2\text{O}_3$  bulks. (c), and (d) shows the corresponding EDS spectrum with elemental composition content. The distributed  $\text{Ga}_2\text{O}_3$  are clearly visible (dark color) in the micrographs, and increased content from 2 to 6wt % added  $\text{Ga}_2\text{O}_3$  in  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  bulk

TABLE 1

Relative density, Hardness, carrier concentration, hall mobility, reduced fermi level, and bandgap of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites

BST/(x-wt%) $\text{Ga}_2\text{O}_3$	Relative density (%)	Hardness (GPa)	Carrier concentration, $n$ ( $10^{19}/\text{cm}^3$ )	Hall mobility, $\mu$ ( $\text{cm}^2/\text{Vs}$ )	Reduced Fermi level, $\zeta_F (= E_f/k_B T)$	Bandgap, $E_g$ ( $2ea_{\text{max}}T_{\text{max}}$ )
0	99.7	0.86	1.72	2.68	0.1969	0.175
2	98.6	0.885	0.84	2.79	-0.7004	0.179
4	98.2	0.95	0.92	2.74	-0.7038	0.18
6	97.9	1.336	1.0	2.64	-0.758	0.176



The Seebeck coefficient of all nanocomposites are positive throughout the measured temperature range from 300 to 500 K, indicates that the holes are majority carriers [17]. The Seebeck coefficient of base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  specimen is increases with increasing temperature gradually, whereas the nanocomposites show rapid decreasing behavior with temperature which might be due to band structural change (see  $\zeta_F$  in Table 1) and increase in bandgap (see  $E_g$  in Table 1) in upon the dispersion of  $\text{Ga}_2\text{O}_3$  nanoparticles. It is obvious that the Seebeck coefficient is significantly improved by the incorporation of  $\text{Ga}_2\text{O}_3$  nanoparticles into the base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample. The Seebeck coefficient of 192  $\mu\text{V}/\text{K}$  is obtained for base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample, which is eminently improved to  $\sim 254 \mu\text{V}/\text{K}$  for the 6wt% of  $\text{Ga}_2\text{O}_3$  dispersed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites. In general, the Seebeck coefficient ( $\alpha$ ) can expressed in terms of carrier concentration  $n_c$  as [18]

$$\alpha = \gamma - \ln n_c \quad (1)$$

where  $\gamma$  is the scattering parameter, and  $n_c$  is the carrier concentration. The measured carrier concentration and hall mobility are shown in the Table 1. It is evident that the carrier concentration of base matrix is about  $1.72 \times 10^{19} \text{ cm}^{-3}$ , which is dramatically decreased up to  $\sim 1.0 \times 10^{19} \text{ cm}^{-3}$  upon the dispersion of the  $\text{Ga}_2\text{O}_3$  nanoparticles in host matrix. K. T. Kim et al argued that the variation in the band structure such a decrease in Fermi energy level (see in Table 1) in nanocomposites would causes for reduction of carrier concentration [17]. Therefore, the rapid decrease in carrier concentration is favorably increases the Seebeck coefficient in the nanocomposites. The present  $\text{Ga}_2\text{O}_3$  dispersed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites show improved Seebeck coefficient than other p-type Bi-Te based nanocomposites [19,20].

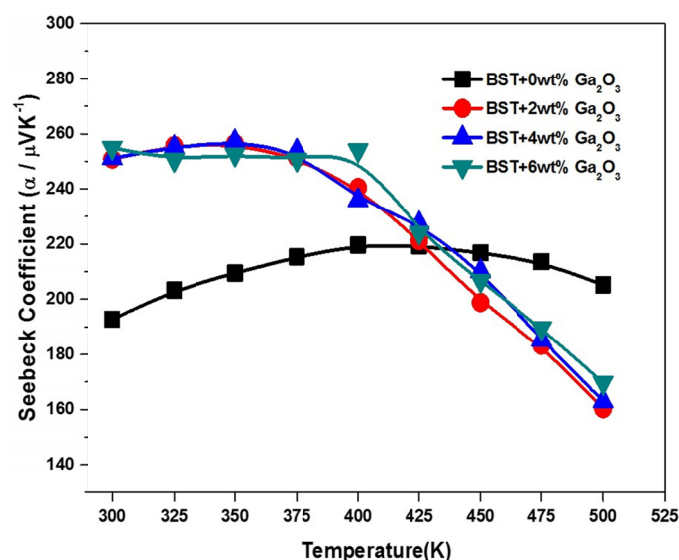


Fig. 4. Temperature dependence of Seebeck coefficient for  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3/(x\text{-wt}\%) \text{Ga}_2\text{O}_3$  ( $x = 0, 2, 4$  and  $6\text{wt}\%$ ) nanocomposite bulk samples

The temperature dependence of the electrical conductivity of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites is presented in Figure 5. The electrical conductivity of all specimens decreased with

increasing for temperature indicating a metal -like behavior. It is clearly shown in Figure 5 that the electrical conductivity is severely affected by the dispersion of  $\text{Ga}_2\text{O}_3$  nanoparticles into base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample. In addition, the electrical conductivity is decreased with increase in  $\text{Ga}_2\text{O}_3$  content, which is mainly due to the scattering of carrier at newly formed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3/\text{Ga}_2\text{O}_3$  interfaces. The electrical conductivity of  $822 \Omega^{-1}\text{cm}^{-1}$  obtained for the base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample, which is ferociously decreased to  $345 \Omega^{-1}\text{cm}^{-1}$  for the 6 wt% of  $\text{Ga}_2\text{O}_3$  dispersed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites. In general, the electrical conductivity is given by [16],

$$\sigma = n_c e \mu \quad (2)$$

where  $e$  is the charge of the carrier. The electrical conductivity of the  $\text{Ga}_2\text{O}_3$  dispersed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites is decreased primarily due to the decrease in carrier concentration (see Table 1). However, the carrier mobility is increased for the nanocomposites, which might be balanced with the carrier concentration as per the equation (2).

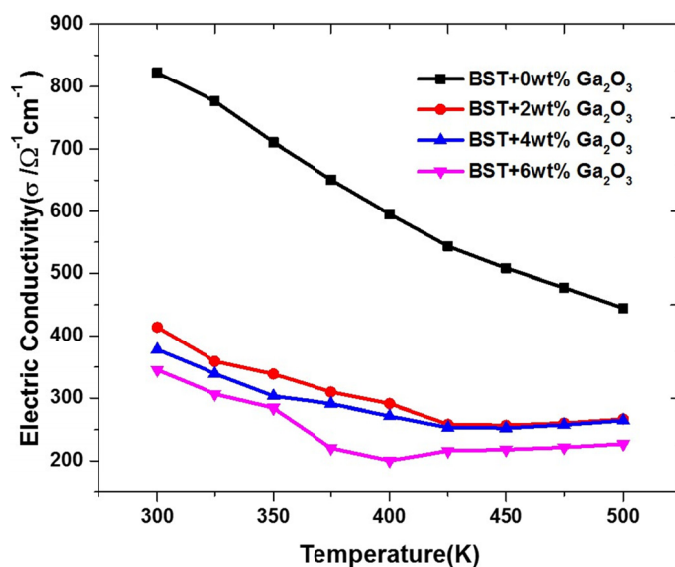


Fig. 5. Temperature dependence of electrical conductivity for  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3/(x\text{-wt}\%) \text{Ga}_2\text{O}_3$  ( $x = 0, 2, 4$  and  $6\text{wt}\%$ ) nanocomposite bulk samples

The temperature dependence of power factor (PF) values is calculated from the measured Seebeck coefficient, and electrical conductivity ( $\text{PF} = \alpha^2 \sigma$ ). The calculated powder factor of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites are shown in Figure 6. The power factor of all samples are decreases with increasing temperature, which is due to the decreasing behavior of electrical conductivity with temperature. The maximum power factor of  $3.24 \text{ W}/\text{mK}^2$  is obtained for the base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  specimen. However, the PF is decreased in the  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites due to severe reduction of electrical conductivity. Further studies are underway to balance the electrical conductivity to attain high power factor values.

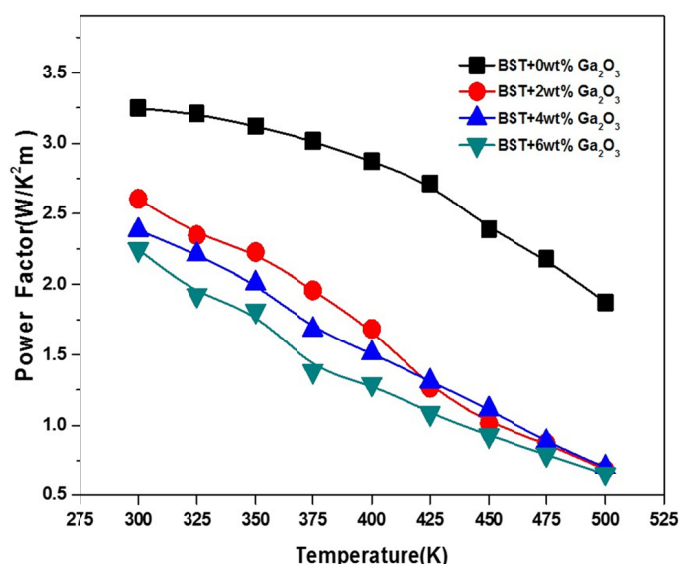


Fig. 6. Temperature dependence of power factor for  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3/(\text{x-wt}\%)\text{Ga}_2\text{O}_3$  ( $\text{x} = 0, 2, 4$  and  $6\text{wt}\%$ ) nanocomposite bulk samples

#### 4. Conclusions

In summary, p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  based nanocomposite powders were successfully fabricated with dispersing 0wt%, 2 wt%, 4wt%, and 6wt% of  $\text{Ga}_2\text{O}_3$  nanoparticles into a  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  host by mechanical milling, subsequently consolidated with spark plasma sintering. The fracture surfaces indicated that the grain sizes were slightly decreases with increasing  $\text{Ga}_2\text{O}_3$  content in host matrix. The Vickers hardness is remarkably improved for the 6wt% dispersed  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites. The dispersion effect of  $\text{Ga}_2\text{O}_3$  on thermoelectric properties of p-type  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  was systematically investigated. The Seebeck coefficient of  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites were significantly improved by the  $\text{Ga}_2\text{O}_3$  nanoparticles dispersion which is mainly due to the decrease in carrier concentration. Besides, the electrical conductivity was decreased. The  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  nanocomposites show low power factor ( $2.6 \text{ W/mK}^2$  for 2wt% $\text{Ga}_2\text{O}_3$ ) than base  $\text{Bi}_{0.5}\text{Sb}_{1.5}\text{Te}_3$  sample ( $3.24 \text{ W/mK}^2$ ) due to their low electrical conductivity.

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of merit (Z) 3.4( $\times 10^{-3}$ ) by using 1.0 kg/batch scale producible polycrystalline thermoelectric material with average figure of merit (ZT) 1.4 and over].

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